

ROITHNER LASERTECHNIK GMBH

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Rev. A1

LED405-01

UV LED

• 405 nm, 18 mW

• Chip: InGaN, 350 x 350 μm, 1 pc.

• 5 mm Clear Molding, Epoxy Resin

• Viewing Angle: 14°





Description

LED405-01 contains one InGaN LED chip die with a typical peak wavelength of **405 nm** and radiation power of **18 mW**. It comes in Ø5 mm clear molding package with soldered lead frame (lead free) and lens molded with epoxy resin.

Maximum Ratings (TCASE=25°C)

| Barrantan | Oh a l | Val | 11.24 | |
|----------------------------|-----------------|------|-------|------|
| Parameter | Symbol | Min. | Max. | Unit |
| Power Dissipation | P_D | | 200 | mW |
| Forward Current | IF | | 50 | mA |
| Pulse Forward Current *1 | I _{FP} | | 100 | mA |
| Reverse Voltage | VF | | 5 | V |
| Thermal Resistance | R_{THJA} | | 200 | K/W |
| Junction Temperature | T_J | | 120 | °C |
| Operating Temperature | T_{CASE} | - 20 | + 100 | °C |
| Storage Temperature | T_{STG} | - 20 | + 100 | °C |
| Lead Solder Temperature *2 | T_{SLD} | | + 265 | °C |

^{*1} duty=1%, pulse width = 10 µs

Electro-Optical Characteristics (TCASE=25°C)

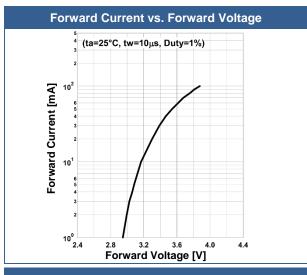
| Parameter | Symbol | Conditions | Min. | Values Typ. | Max. | Unit |
|----------------------|------------------|------------------------|------|----------------|------|----------|
| Peak Wavelength | λ_P | I _F =20mA | 400 | | 410 | nm |
| Half Width | $\Delta \lambda$ | I _F =20mA | | 19 | | nm |
| Forward Voltage | VF | I _F =20mA | | 3.3 | 4.0 | V |
| | V_{FP} | I _{FP} =100mA | | 3.9 | | |
| Radiated Power *1 | Д. | I _F =20mA | | 18 | | mW |
| Radiated Fower | Po | I _{FP} =100mA | | 69 | | |
| Dadient Intensity *2 | lE | I _F =20mA | | 150 | | mW/sr |
| Radiant Intensity *2 | | I _{FP} =100mA | | 580 | | IIIVV/SI |
| Viewing Angle | 2θ1/2 | I _F =20mA | | 14 | | deg. |
| Rise Time | t r | I _F =20mA | | 10 | | ns |
| Fall Time | t f | I _F =20mA | | 15 | | ns |

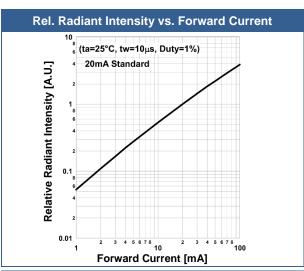
^{*1} measured by S3584-08

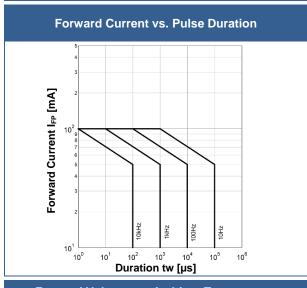
^{*2} must be completed within 5 seconds

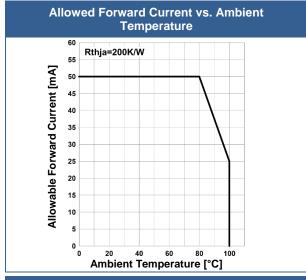
^{*2} measured by CIE127-2007 Condition B

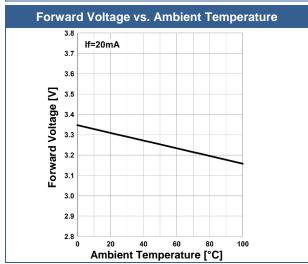
Typical Performance Curves

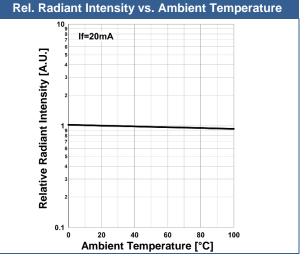










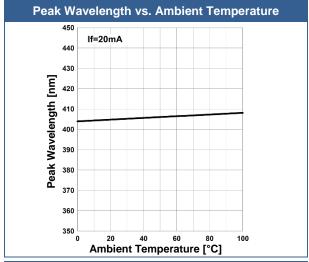


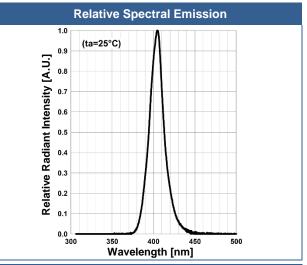


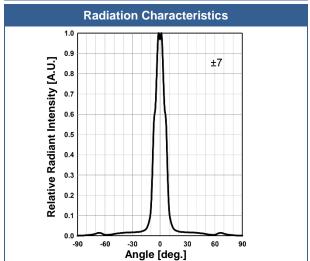
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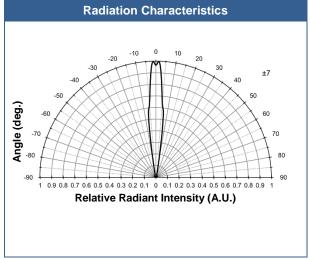
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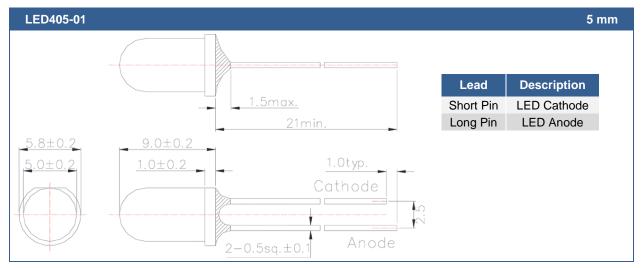








Outline Dimensions



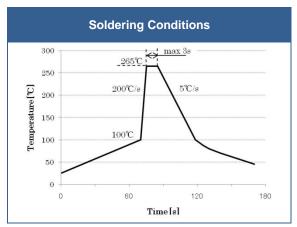
All Dimensions in mm

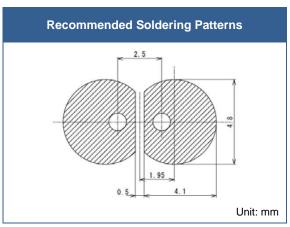
Precautions

Soldering:

- · Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

Recommended soldering conditions:





Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS

DO NOT USE ultrasonic cleaners

Static Electricity:

LEDs are sensitive to electrostatic discharge (ESD). Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

Radiation:

During operation these LEDs do emit light, which could be hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. Protective glasses if needed. It is further advised to attach a warning label on products/systems.

Operation:

Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device.

Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

Revisions History

| Rel. | Rel. Date | Chapter | Modification | Page |
|------|------------|---------|-----------------|------|
| A1 | 2019-06-01 | - | Initial release | - |

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